Single 2-input NOR gate Rev. 1 — 28 January 2013

Product data sheet

General description 1.

The 74LVC1G02-Q100 provides the single 2-input NOR function.

Input can be driven from either 3.3 V or 5 V devices. These features allow the use of these devices in a mixed 3.3 V and 5 V environment.

Schmitt-trigger action at all inputs makes the circuit tolerant for slower input rise and fall time.

This device is fully specified for partial power-down applications using I_{OFF}. The I_{OFF} circuitry disables the output, preventing the damaging backflow current through the device when it is powered down.

This product has been qualified to the Automotive Electronics Council (AEC) standard Q100 (Grade 1) and is suitable for use in automotive applications.

2. Features and benefits

- Automotive product qualification in accordance with AEC-Q100 (Grade 1)
- Specified from –40 °C to +85 °C and from –40 °C to +125 °C
- Wide supply voltage range from 1.65 V to 5.5 V
- High noise immunity
- Complies with JEDEC standard:
 - JESD8-7 (1.65 V to 1.95 V)
 - JESD8-5 (2.3 V to 2.7 V)
 - JESD8-B/JESD36 (2.7 V to 3.6 V)
- ± 24 mA output drive (V_{CC} = 3.0 V)
- CMOS low power consumption
- Latch-up performance exceeds 250 mA
- Direct interface with TTL levels
- Inputs accept voltages up to 5 V
- Multiple package options
- ESD protection:
 - MIL-STD-883, method 3015 exceeds 2000 V
 - HBM JESD22-A114F exceeds 2000 V
 - MM JESD22-A115-A exceeds 200 V (C = 200 pF, R = 0 Ω)



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Ordering information 3.

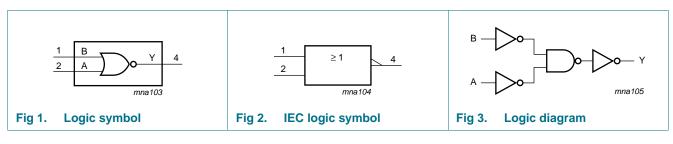
Table 1. Ordering in	nformation			
Type number	Package			
	Temperature range	Name	Description	Version
74LVC1G02GW-Q100	–40 °C to +125 °C	TSSOP5	plastic thin shrink small outline package; 5 leads; body width 1.25 mm	SOT353-1
74LVC1G02GV-Q100	–40 °C to +125 °C	SC-74A	plastic surface-mounted package; 5 leads	SOT753

Marking 4.

Type number	Marking code ^[1]
74LVC1G02GW-Q100	VB
74LVC1G02GV-Q100	V02

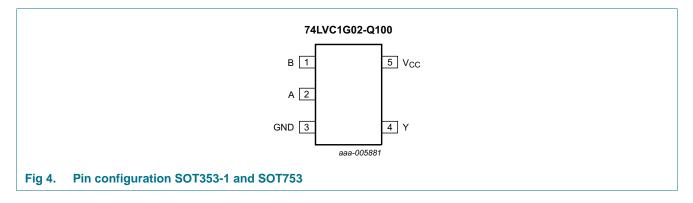
[1] The pin 1 indicator is located on the lower left corner of the device, below the marking code.

Functional diagram 5.



Pinning information 6.

6.1 Pinning



6.2 Pin description

Table 3.	Pin description	
Symbol	Pin	Description
В	1	data input
А	2	data input
GND	3	ground (0 V)
Υ	4	data output
V _{CC}	5	supply voltage

7. Functional description

Table 4.Function table^[1]

Inputs		Outputs
Α	В	Y
L	L	Н
L	Н	L
Н	L	L
Н	Н	L

[1] H = HIGH voltage level; L = LOW voltage level.

8. Limiting values

Table 5.Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

			•		,
Symbol	Parameter	Conditions	Min	Max	Unit
V _{CC}	supply voltage		-0.5	+6.5	V
I _{IK}	input clamping current	V _I < 0 V	-50	-	mA
VI	input voltage		<u>[1]</u> –0.5	+6.5	V
I _{OK}	output clamping current	$V_{\rm O}$ > $V_{\rm CC}$ or $V_{\rm O}$ < 0 V	-	±50	mA
Vo	output voltage	Active mode	<u>[1][2]</u> –0.5	V _{CC} + 0.5	V
		Power-down mode	<u>[1][2]</u> –0.5	+6.5	V
Ι _Ο	output current	$V_{O} = 0 V$ to V_{CC}	-	±50	mA
I _{CC}	supply current		-	+100	mA
I _{GND}	ground current		-100	-	mA
P _{tot}	total power dissipation	T_{amb} = -40 °C to +125 °C	<u>[3]</u>	250	mW
T _{stg}	storage temperature		-65	+150	°C

[1] The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

[2] When $V_{CC} = 0 V$ (Power-down mode), the output voltage can be 5.5 V in normal operation.

[3] For TSSOP5 and SC-74A packages: above 87.5 °C the value of Ptot derates linearly with 4.0 mW/K.

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9. Recommended operating conditions

Table 6.	le 6. Recommended operating conditions					
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V _{CC}	supply voltage		1.65	-	5.5	V
VI	input voltage		0	-	5.5	V
Vo	output voltage	Active mode	0	-	V _{CC}	V
		V _{CC} = 0 V; Power-down mode	0	-	5.5	V
T _{amb}	ambient temperature		-40	-	+125	°C
$\Delta t / \Delta V$	input transition rise and fall rate	V_{CC} = 1.65 V to 2.7 V	-	-	20	ns/V
		$V_{CC} = 2.7 \text{ V to } 5.5 \text{ V}$	-	-	10	ns/V

10. Static characteristics

Table 7. Static characteristics

At recommended operating conditions. Voltages are referenced to GND (ground = 0 V).

Symbol Parameter		Conditions	-40 °	°C to +8	5 °C	-40 °C te	Unit	
			Min	Typ[1]	Max	Min	Max	
VIH	HIGH-level	V _{CC} = 1.65 V to 1.95 V	$0.65V_{CC}$	-	-	0.65V _{CC}	-	V
	input voltage	V_{CC} = 2.3 V to 2.7 V	1.7	-	-	1.7	-	V
		$V_{CC} = 2.7 \text{ V to } 3.6 \text{ V}$	2.0	-	-	2.0	-	V
		V_{CC} = 4.5 V to 5.5 V	$0.7V_{CC}$	-	-	$0.7V_{CC}$	-	V
VIL	LOW-level	V_{CC} = 1.65 V to 1.95 V	-	-	$0.35V_{CC}$	-	$0.35V_{CC}$	V
	input voltage	V_{CC} = 2.3 V to 2.7 V	-	-	0.7	-	0.7	V
		$V_{CC} = 2.7 \text{ V to } 3.6 \text{ V}$	-	-	0.8	-	0.8	V
		V_{CC} = 4.5 V to 5.5 V	-	-	$0.3V_{CC}$	-	$0.3V_{CC}$	V
V _{OH}	HIGH-level	$V_{I} = V_{IH} \text{ or } V_{IL}$						
	output voltage	I _O = −100 μA; V _{CC} = 1.65 V to 5.5 V	$V_{CC}-0.1$	-	-	$V_{CC}-0.1$	-	V
		$I_0 = -4 \text{ mA}; V_{CC} = 1.65 \text{ V}$	1.2	-	-	0.95	-	V
		$I_{O} = -8 \text{ mA}; V_{CC} = 2.3 \text{ V}$	1.9	-	-	1.7	-	V
		$I_{O} = -12 \text{ mA}; V_{CC} = 2.7 \text{ V}$	2.2	-	-	1.9	-	V
		$I_{O} = -24 \text{ mA}; V_{CC} = 3.0 \text{ V}$	2.3	-	-	2.0	-	V
		$I_{O} = -32 \text{ mA}; V_{CC} = 4.5 \text{ V}$	3.8	-	-	3.4	-	V
V _{OL}	LOW-level	$V_{I} = V_{IH} \text{ or } V_{IL}$						
	output voltage	I _O = 100 μA; V _{CC} = 1.65 V to 5.5 V	-	-	0.1	-	0.1	V
		I _O = 4 mA; V _{CC} = 1.65 V	-	-	0.45	-	0.70	V
		$I_0 = 8 \text{ mA}; V_{CC} = 2.3 \text{ V}$	-	-	0.3	-	0.45	V
		I_{O} = 12 mA; V_{CC} = 2.7 V	$_{\rm O}$ = 12 mA; V _{CC} = 2.7 V 0.	0.4	-	0.60	V	
		I_{O} = 24 mA; V_{CC} = 3.0 V	-	-	0.55	-	0.80	V
		I_{O} = 32 mA; V_{CC} = 4.5 V	-	-	0.55	-	0.80	V
I	input leakage current	$V_{I} = 5.5 \text{ V or GND};$ $V_{CC} = 0 \text{ V to } 5.5 \text{ V}$	-	±0.1	±5	-	±100	μA

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At recommended operating conditions. Voltages are referenced to GND (ground = 0 V).								
Symbol	SymbolParameterConditions-40 °C to +85 °C-40 °C to +125 °C						Unit	
			Min Typ ^[1] Max Min Max					
I _{OFF}	power-off leakage current	$V_{CC} = 0$ V; V_{I} or $V_{O} = 5.5$ V	-	±0.1	±10	-	±200	μA
I _{CC}	supply current	$V_{I} = 5.5 V \text{ or GND}; I_{O} = 0 A;$ $V_{CC} = 1.65 V \text{ to } 5.5 V$	-	0.1	10	-	200	μΑ
ΔI_{CC}	additional supply current		-	5	500	-	5000	μΑ
Cl	input capacitance	V_{CC} = 3.3 V; V_{I} = GND to V_{CC}	-	5	-	-	-	pF

Table 7. Static characteristics ...continued

At recommended operating conditions. Voltages are referenced to GND (ground = 0 V).

[1] All typical values are measured at V_{CC} = 3.3 V and T_{amb} = 25 °C.

11. Dynamic characteristics

Table 8.Dynamic characteristics

Voltages are referenced to GND (ground = 0 V); for load circuit see <u>Figure 6</u>.

Symbol	Parameter	Conditions	-40 °C to +85 °C -40 °C to +125 °C		o +125 °C	Unit			
				Min Typ ^[1] Max Min Max				Max	
t _{pd}	propagation delay	A, B to Y; see Figure 5	[2]						
		V_{CC} = 1.65 V to 1.95 V		1.0	3.2	8.0	1.0	10.5	ns
		V_{CC} = 2.3 V to 2.7 V		0.5	2.2	5.5	0.5	7.0	ns
		$V_{CC} = 2.7 V$		0.5	2.5	5.5	0.5	7.0	ns
		V_{CC} = 3.0 V to 3.6 V		0.5	2.1	4.5	0.5	6.0	ns
		V_{CC} = 4.5 V to 5.5 V		0.5	1.7	4.0	0.5	5.5	ns
C _{PD}	power dissipation capacitance	$V_I = GND \text{ to } V_{CC};$ $V_{CC} = 3.3 \text{ V}$	<u>[3]</u>	-	14	-	-	-	pF

[1] Typical values are measured at T_{amb} = 25 °C and V_{CC} = 1.8 V, 2.5 V, 2.7 V, 3.3 V and 5.0 V respectively.

[2] t_{pd} is the same as t_{PLH} and t_{PHL} .

[3] C_{PD} is used to determine the dynamic power dissipation (P_D in μW).

 $P_{D} = C_{PD} \times V_{CC}^{2} \times f_{i} \times N + \sum (C_{L} \times V_{CC}^{2} \times f_{o}) \text{ where:}$

 f_i = input frequency in MHz;

 $f_o = output frequency in MHz;$

 C_L = output load capacitance in pF;

V_{CC} = supply voltage in V;

N = number of inputs switching;

 $\Sigma(C_L \times V_{CC}{}^2 \times f_o)$ = sum of outputs.

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12. Waveforms

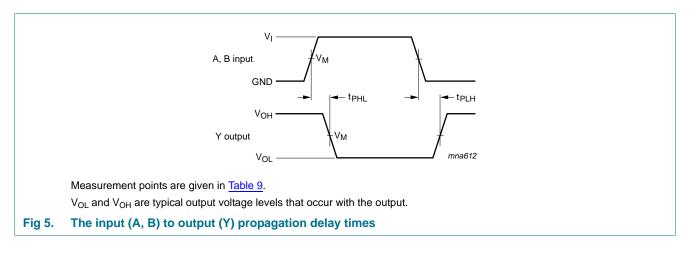
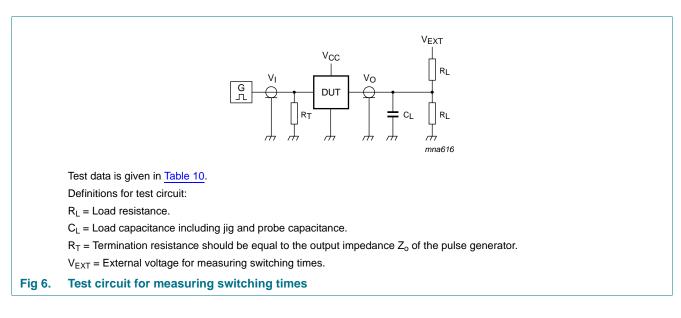


Table 9. Measurement points

Supply voltage	Input	Output
V _{cc}	V _M	V _M
1.65 V to 1.95 V	0.5V _{CC}	0.5V _{CC}
2.3 V to 2.7 V	0.5V _{CC}	0.5V _{CC}
2.7 V	1.5 V	1.5 V
3.0 V to 3.6 V	1.5 V	1.5 V
4.5 V to 5.5 V	0.5V _{CC}	0.5V _{CC}



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Supply voltage	Input		Load	Load		
V _{cc}	VI	$t_r = t_f$	CL	RL	t _{PLH} , t _{PHL}	
1.65 V to 1.95 V	V _{CC}	\leq 2.0 ns	30 pF	1 kΩ	open	
2.3 V to 2.7 V	V _{CC}	\leq 2.0 ns	30 pF	500 Ω	open	
2.7 V	2.7 V	\leq 2.5 ns	50 pF	500 Ω	open	
3.0 V to 3.6 V	2.7 V	\leq 2.5 ns	50 pF	500 Ω	open	
4.5 V to 5.5 V	V _{CC}	≤ 2.5 ns	50 pF	500 Ω	open	

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13. Package outline

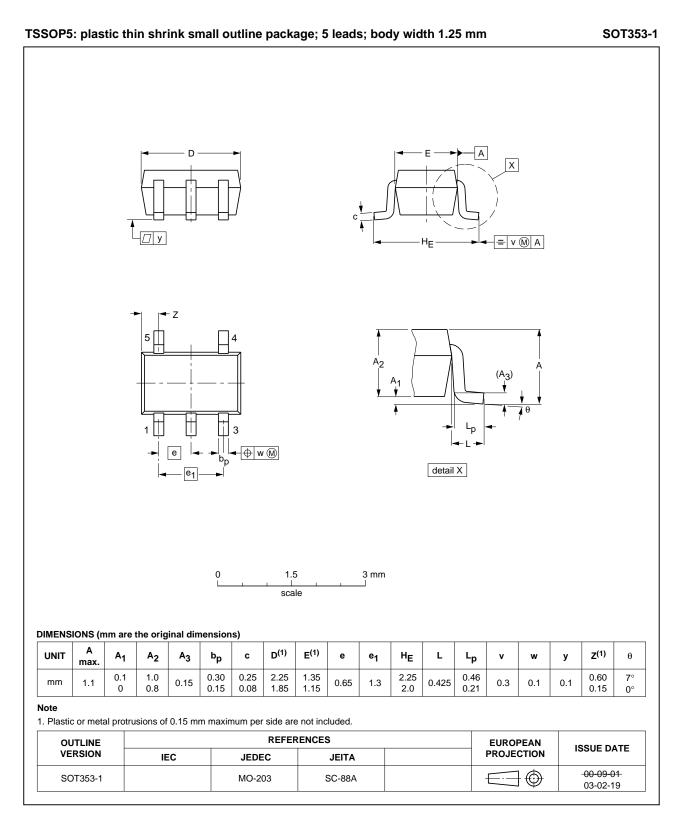


Fig 7. Package outline SOT353-1 (TSSOP5)

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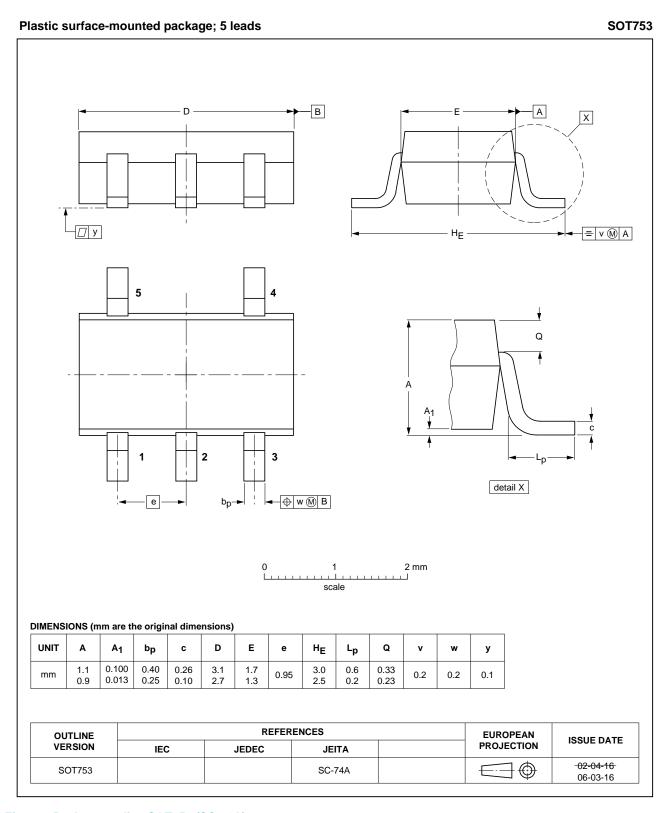


Fig 8. Package outline SOT753 (SC-74A)

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14. Abbreviations

AcronymDescriptionCMOSComplementary Metal Oxide SemiconductorDUTDevice Under TestESDElectroStatic DischargeHBMHuman Body ModelMILMilitaryMMMachine Model	Table 11.	Abbreviations		
DUTDevice Under TestESDElectroStatic DischargeHBMHuman Body ModelMILMilitary	Acronym	Description		
ESDElectroStatic DischargeHBMHuman Body ModelMILMilitary	CMOS	Complementary Metal Oxide Semiconductor		
HBM Human Body Model MIL Military	DUT	Device Under Test		
MIL Military	ESD	ElectroStatic Discharge		
······································	HBM	Human Body Model		
MM Machine Model	MIL	Military		
	MM	Machine Model		
TTL Transistor-Transistor Logic	TTL	Transistor-Transistor Logic		

15. Revision history

Table 12. Revision hist				
Document ID	Release date	Data sheet status	Change notice	Supersedes
74LVC1G02_Q100 v.1	20130128	Product data sheet	-	-

16. Legal information

16.1 Data sheet status

Document status[1][2]	Product status ^[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

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